Electronic Acknowledgement Receipt				
EFS ID:	7453281			
Application Number:	10588833			
International Application Number:				
Confirmation Number:	4453			
Title of Invention:	Nanostructures Containing Metal Semiconductor Compounds			
First Named Inventor/Applicant Name:	Charles M. Lieber			
Customer Number:	86110			
Filer:	Timothy J. Oyer/Angela Griffith			
Filer Authorized By:	Timothy J. Oyer			
Attorney Docket Number:	H0498.70217US02			
Receipt Date:	20-APR-2010			
Filing Date:	02-SEP-2008			
Time Stamp:	18:30:20			
Application Type:	U.S. National Stage under 35 USC 371			

Payment information:

Submitted with Payment	yes
Payment Type	Credit Card
Payment was successfully received in RAM	\$180
RAM confirmation Number	5063
Deposit Account	232825
Authorized User	OYER,TIMOTHY J.

The Director of the USPTO is hereby authorized to charge indicated fees and credit any overpayment as follows:

Charge any Additional Fees required under 37 C.F.R. Section 1.17 (Patent application and reexamination processing fees)

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.			
1	Miscellaneous Incoming Letter	H049870217US02-TRN-TJO.pdf	46206	no	2			
	Miscendicods incoming cetter		a358ca3ebbdab3d5a2571d7bf30f12c8a0c 1b90e					
Warnings:								
Information:				-				
2	Fee Worksheet (PTO-875)	H049870217US02-FEE-TJO.pdf	65888	no	1			
			9215853d4a43c3164a92d50dac/c2e1fe98e 5as9					
Warnings:								
Information:				1				
3		H049870217US02-AMN-TJO.	279456	ves	7			
, ,		pdf	259fei 1c399c58ed7cef81b99fa0c2112c12 16db					
	Multipart Description/PDF files in .zip description							
	Document De	scription	Start	Start End				
	Amendment/Req. Reconsideration-After Non-Final Reject		1	1				
	Claims		2	4				
	Applicant Arguments/Remarks Made in an Amendment		5	7				
Warnings:								
Information:		T						
4		H049870217US02-IDS-TJO.pdf	150259	yes	4			
			3f4801973f990ff928abSeauc7ca6Sd2f39bb 2b0					
	Multipart Description/PDF files in .zip description							
	Document Description Transmittal Letter Information Disclosure Statement (IDS) Filed (SB/08)		Start	End				
			1	3				
			4	4				
Warnings:								
Information:								
5	NPL Documents	H049870217US02-NPL1-TJO. pdf	159797	no	4			
			066daa349a4c2177f31295807e690e139a3 d1f26					
Warnings:								
Information:								

	Total Files Size (in bytes): 731917						
Information:							
Warnings:							
		8c29903143bHbc80306f14d04495dc243a 79a1f					
6	Fee Worksheet (PTO-875)	fee-info.pdf	30311	no	2		

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-[d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.